WISE 2027
SPONSORSHIP PROSPECTUS

World Innovation Summit on Engineering and Emerging Technologies

16–17 April 2027

Indus International University
Una, Himachal Pradesh, India

Organised by Wissira Research Lab (USA)
in collaboration with Indus International University

Partner with WISE 2027 to support research, innovation, and meaningful exchange between academia and industry.

An Invitation to Partner

Dear Industry Leader,

In a rapidly evolving technological landscape, collaboration between academia and industry can help translate research into practical solutions. WISE 2027 invites organisations interested in engineering, artificial intelligence, computing, educational technologies, and emerging fields to explore sponsorship and partnership opportunities.

The World Innovation Summit on Engineering and Emerging Technologies (WISE 2027) is scheduled for 16–17 April 2027 at Indus International University, Una, Himachal Pradesh, India. The summit aims to provide a platform for researchers, academicians, industry professionals, innovators, and students to exchange ideas and discuss research and technology developments.

We welcome conversations with organisations that wish to support research engagement, innovation, education, and academia–industry collaboration.

About WISE 2027

WISE 2027 is an international conference focused on engineering and emerging technologies. Its intended scope includes artificial intelligence and machine learning, data science, cybersecurity, cloud computing, Internet of Things, robotics, software engineering, educational technologies, digital transformation, and sustainable engineering.

Conference Objectives

Knowledge exchange	Bring together researchers, educators, students, and industry professionals.
Technology and innovation	Encourage discussion of emerging methods, systems, and applications.
Academic–industry engagement	Create opportunities to explore collaboration around research and practical challenges.
Interdisciplinary research	Support exchange across engineering, computing, education, and related fields.

Why Consider Sponsoring?

Sponsorship may provide visibility among conference participants and opportunities to connect with researchers, academic institutions, and professionals interested in technology and innovation. Specific recognition and deliverables should be agreed with the organising committee in advance.

Sponsorship Opportunities

The following are proposed sponsorship tiers for discussion. Package values and deliverables are not yet fixed; they should be confirmed in a written agreement before being advertised or accepted.

PLATINUM PARTNER

• Prominent sponsor recognition in agreed conference materials

• Logo placement in selected digital promotional assets

• Acknowledgement during a designated conference session

• Opportunity to provide a company profile for conference materials

• Additional benefits by mutual agreement

GOLD PARTNER

• Gold sponsor recognition in agreed materials

• Logo placement in selected conference promotions

• Acknowledgement in designated announcements

• Opportunity to share company information

• Additional benefits by mutual agreement

SILVER PARTNER

• Silver sponsor recognition

• Logo inclusion in selected sponsor listings

• Acknowledgement in conference materials

• Opportunity to support a designated activity

Other Partnership Options

Organisations may also discuss support for a conference session, student or early-career researcher initiative, workshop, technology showcase, or other activity. Availability and benefits will depend on the final programme and written agreement.

Potential Sponsor Engagement

• Brand visibility through mutually agreed promotional materials
• Professional networking and research engagement
• Opportunities to discuss industry challenges and research interests
• Support for educational and research activities
• Potential conversations about future institutional collaboration

How to Become a Partner

1. Contact the organising committee to express interest.
2. Share your organisation's goals and preferred level of support.
3. Discuss available benefits, contribution, timing, and conditions.
4. Confirm the arrangement in writing before payment or public announcement.

Important Terms

• Sponsorship recognition and benefits must be confirmed in writing with the organisers.
• Sponsorship does not influence peer-review decisions, paper acceptance, or publication outcomes.
• Logo use, promotional content, speaking opportunities, or exhibition arrangements require prior approval.
• Sponsorship contributions, cancellation terms, invoices, and payment details should be agreed directly with the organisers.
• Proceedings are proposed for publication in Springer Nature's Lecture Notes in Networks and Systems (LNNS), subject to publisher editorial evaluation and approval. Sponsorship does not guarantee publication or indexing.

Contact the Organising Committee

WISE 2027
World Innovation Summit on Engineering and Emerging Technologies
Dates: 16–17 April 2027
Venue: Indus International University, Una, Himachal Pradesh, India
Organiser: Wissira Research Lab (USA)
In collaboration with: Indus International University
Email:editor@wissira.us
Website:wise-conf.wissira.us

LET'S BUILD RESEARCH AND INNOVATION TOGETHER

Contact the WISE 2027 organising committee to discuss a suitable sponsorship or partnership arrangement.

This prospectus outlines proposed sponsorship opportunities. Final packages, amounts, and benefits are subject to confirmation by the WISE 2027 organising committee.